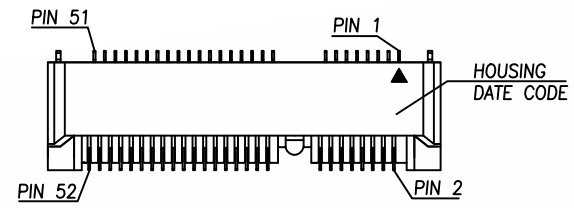
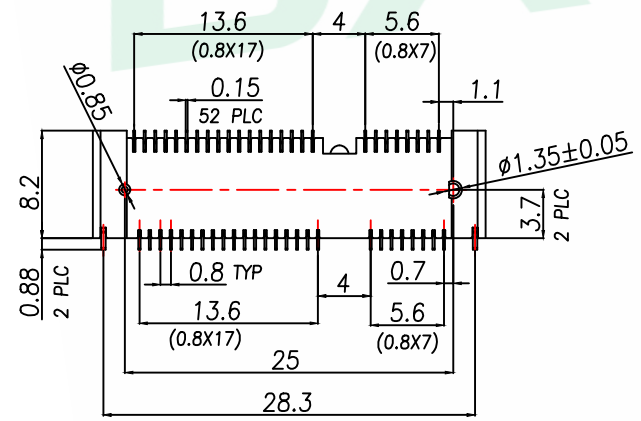
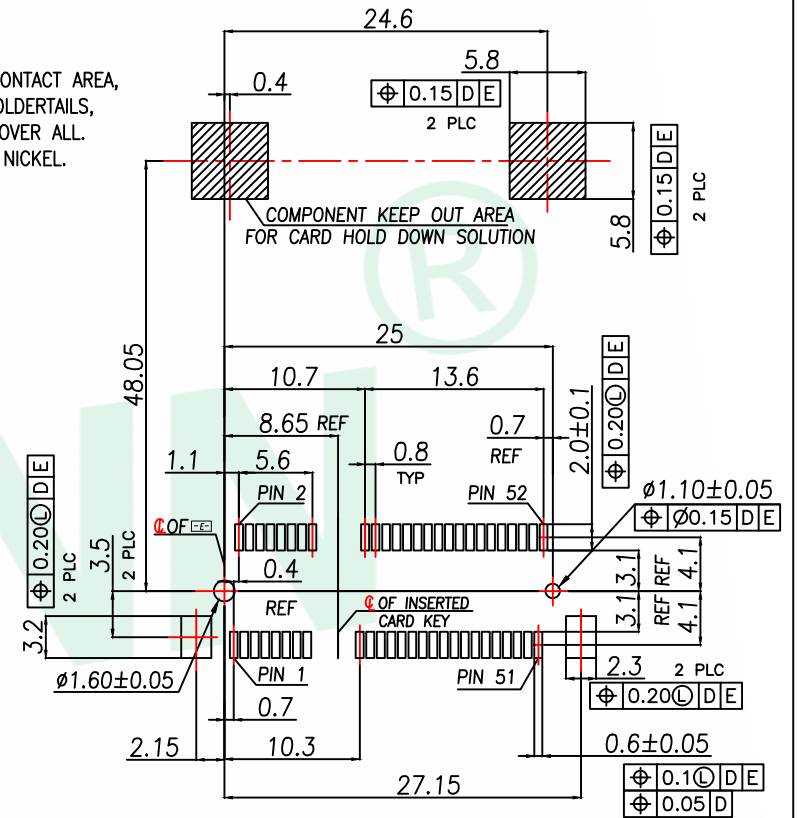
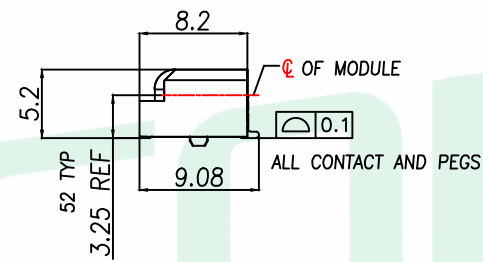
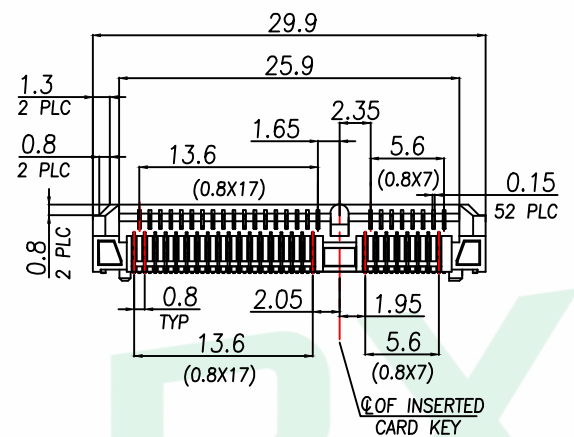


REV.	DESCRIPTION	ECN NO.	NAME	DATE



NOTES:

- MATERIAL:
HOUSING: THERMOPLASTIC, HIGH TEMP, UL94V-0, BLACK COLOR,
CONTACTS: COPPER ALLOY.
PEGS: COPPER ALLOY.
- FINISH:
CONTACTS: SELECTED GOLD PLATING ON THE CONTACT AREA,
1u" MIN. GOLD PLATING ON THE SOLDERTAILS,
50 u" MIN. NICKEL UNDERPLATING OVER ALL.
PEGS: 120u" MIN. MATTE-TIN OVER 50u" MIN. NICKEL.



SPECIFICATION

CURRENT RATING : 0.5A 50V AC/DC
 CONTACT RESISTANCE : 55 mΩ MAX
 INSULATION RESISTANCE : 500 MΩ MIN AT 500V DC
 OPERATING TEMPERATURE : -55°C~80°C

-D- IS THE TOP SURFACE OF PCB.
 RECOMMENDED P.C.BOARD PATTERN LAYOUT

GENERAL TOLERANCE	DONGGUAN BAOXUN PRECISION TECHNOLOGY CO., LTD		
DIM. TOL.	TITLE: 0.80MM PITCH MINPCIEXPRESS HIGH=5.2mm 52 PIN CONNECTOR		
x. ±0.30	DWG. NO.: PCIE-H5.2-P5236	CHECKED: MAX	
x.x ±0.25	PART NO.: PCIE-H5.2-P5236	DRAWN: ELLA	
x.xx ±0.15	UNIT: mm	SCALE: none	
GENERAL ANGLE: x. ±5.0°	SHEET: 1 of 1	DWG. SIZE: A4	LAYER: bxconn
x.x' ±1.0°	APPROVED: WILL		
x.xx'			